## PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

## **CONVEYING PARTY DATA**

Name	Execution Date
Reed T. Hentges	10/06/2006
Kurt C. Swanson	10/06/2006
Peter F. Ladwig	10/06/2006

#### **RECEIVING PARTY DATA**

Name:	Hutchinson Technology Incorporated	
Street Address:	40 West Highland Park Drive N.E.	
City:	Hutchinson	
State/Country:	MINNESOTA	
Postal Code:	55350-9784	

#### PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	11548177

#### **CORRESPONDENCE DATA**

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ATTORNEY DOCKET NUMBER:	17310-337628
NAME OF CURMITTER.	Walter C. Lindor

NAME OF SUBMITTER: Walter C. Linder

Total Attachments: 2

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PATENT REEL: 018374 FRAME: 0246

# ASSIGNMENT

Attorney Docket No.: 17310-337628 Page 1 of 2 First Named Inventor: HENTGES, Reed T.

MULTI-LAYER GROUND PLANE STRUCTURES FOR

INTEGRATED LEAD SUSPENSIONS

WHEREAS, we, Reed T. Hentges, a United States citizen, residing at 1302 Leo Lane, Buffalo, MN 55313, Kurt C. Swanson, a United States citizen, residing at 1124 Lewis Avenue SW, Hutchinson, MN 55350, and Peter F. Ladwig, a United States citizen, residing at 166622 206th Circle, Hutchinson, MN 55350, have invented certain new and useful improvements as described in an application entitled MULTI-LAYER GROUND PLANE STRUCTURES FOR INTEGRATED LEAD SUSPENSIONS, in which an application was made for Letters Patent of the United States, the application having been executed on even date herewith, and/or being identified in the United States Patent and Trademark Office by Application No. \_\_\_\_\_\_, filed \_\_\_\_\_\_, and

WHEREAS, Hutchinson Technology Incorporated, Corporation of the State of Minnesota, and having an address of 40 West Highland Park Drive N.E., Hutchinson, MN 55350-9784, United States, is desirous of acquiring the entire right, title and interest in and to the invention, the application, and any and all Letters Patent or similar legal protection, foreign or domestic, to be obtained therefor;

NOW. THEREFORE, for good and valuable consideration, the receipt and adequacy of which are hereby acknowledged, we transfer to Assignee, its successors and assigns, my entire right, title, and interest in and to the invention, the above-identified patent application, corresponding domestic applications (including provisionals. divisionals, continuations, and continuations-in-part), corresponding foreign applications, all Letters Patent or similar legal protection issuing thereon, and all rights and benefits under any applicable treaty or convention; and we authorize the Commissioner of Patents and Trademarks of the United States or foreign equivalent thereof to issue the Letters Patent or similar legal protection to the Assignee.

We authorize the Assignee, its successors and assigns, to insert in this instrument the filing date and application number of the application when ascertained. We authorize the Assignee, its successors and assigns, or anyone it may properly designate, to apply for Letters Patent or similar legal protection, in its own name if desired, in any and all foreign countries.

We represent to the Assignee, its successors and assigns, that we have not and shall not execute any writing or do any act whatsoever conflicting with this Assignment. We, or our executors or administrators, will at any time upon request, without additional consideration, but at the expense of the Assignee, its successors and assigns, execute such additional writings and do such additional acts as the Assignee, its successors and assigns, may deem desirable to perfect its enjoyment of this grant, and render all assistance in making application for and obtaining. maintaining, and enforcing the Letters Patent or similar legal protection on the invention in any and all countries.

CERTIFICATE OF ACKNOWLEDGMENT

STATE OF The

COUNTY OF Mc Lead

Subscribed and sworn to before me, a Notary Public, this 6 day of 0 1, 0, 0

My Comm. Exp. Jan. 31, 2009 

Marilipo a. Zinimirmana Notary Public

(SEAL)

# ASSIGNMENT

Attorney Docket No.: 17310-337628

Page 2 of 2

First Named Inventor: HENTGES, Reed T.

le: MULTI-LAYER GROUND PLANE STRUCTURES FOR

INTEGRATED LEAD SUSPENSIONS

Kunt C. Swanson

#### CERTIFICATE OF ACKNOWLEDGMENT

STATE OF War. : SS. COUNTY OF THE Leo d. )

Subscribed and sworn to before me, a Notary Public, this <u>lo</u> day of <u>Ott</u>, 2006.

Marily a. Zimmermann Notary Public (SEAL) MARILYN A. ZIMMERMANN NOTARY PUBLIC-MINNESOTA My Comm. Exp. Jan. 31, 2009

CERTIFICATE OF ACKNOWLEDGMENT

STATE OF WW

COUNTY OF the Read

Subscribed and sworn to before me, a Notary Public, this <u>le</u> day of <u>Oct</u>, 2006.

Marilys a. Zimmermann) Notary Public

(SEAL)

MARILYN A. ZIMMERMANN NOTANY PUBLIC-MINNESCTA My Comin. Exp. Jan. 31, 2009

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**RECORDED: 10/11/2006** 

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